ASSOCIATION CONNECTING ALLCTROMICS INDUSTRIES®	IPC. Bannockl	ourn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarat he declaration e	ion of the succession of the s	ubstances s all lowe	within the m r level mater	nanufacture ials for wh	er listed iter hich the mar	n. Note: if iufacturer	the item is an as has engineering	ssembly with low responsibility.
				Form Type <sup>5</sup> Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					us Materia	als and Mfg Information			
upplier Information														
Company name* Co			Company unique ID			Unique ID Authority					Response Date*			
onsemi											2024-05-19			
Contact Name Title - Contact			ct		Phone - Contact*				Email - Contact*					
Product-Env-Stewards Product En			Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Rep			epresentative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Envi			viro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	r Item Number Mfr Item Nur		Number Mfr Item Name			Effective Date	Version	ion Manufacturing Site		We	eight*	UOM	Unit Type	
	CM1442	CM1442-08CP 8 CH EMI FILTI		R ARRAY		2024-05-19		(	CNQ		4.5	14124	mg	Each
Ianufacturing Proccess Information	ation													
Terminal Plating / Grid Array M	Terminal Plating / Grid Array Material Terminal Base Allo		Alloy	J-STD-020 MSL Rating		Peak Process Body Temperature Max Time at Peak		e at Peak T	Temperature Number of Reflow Cycles					
SnAgCu CU Alloy			1		260		С	30		seconds	3			
omments														
vel 1 - maximum time at peak temperat	ure during so	ldering is 10-3	0 seconds											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).										
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure		
Backside Protection Film	0.192603	mg		Epoxy resin	proprietary data		0.0403	mg		
			Supplier	Carbon Black (C)	1333-86-4		0.0035	mg		
			Supplier	Acrylic resins	Proprietary Data		0.0403	mg		
			Supplier	Silica (SiO2)	14464-46-1		0.1084	mg		
Die	3.05181	mg	Supplier	Silicon (Si)	7440-21-3		3.0518	mg		
Solder Ball	1.210208	mg	Supplier	Silver (Ag)	7440-22-4		0.0315	mg		
			Supplier	Tin (Sn)	7440-31-5		1.1715	mg		
			Supplier	Copper (Cu)	7440-50-8		0.0073	mg		
Under Bump Metal	0.059503	mg	Supplier	Titanium (Ti)	7440-32-6		0.0004	mg		
			Supplier	Copper (Cu)	7440-50-8		0.0591	mg		